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APR 3 0 2001

OFFICE OF PETITIONS

A/C PATENTS

In re Application of Lee, et al. Application No. 09/687,048 Filed: October 13, 2000 Attorney Dkt. No. 45475-00026 For: LEADFRAME AND SEMICONDUCTOR PACKAGE WITH IMPROVED SOLDER JOINT STRENGTH

DECISION ACCORDING STATUS UNDER 37 CFR 1.47(a)

This is in response to the petition under  $37\ \text{CFR}\ 1.47(a)$ , filed March 23, 2001.

The above-identified application was filed October 13, 2000 without an executed oath or declaration. The application names Tae Heon Lee, Young Suk Chung, and Mu Hwan Seo as joint inventors.

Accordingly, on November 24, 2000, a Notice to File Missing Parts of Application ("Notice") was mailed, requiring an executed oath or declaration, and a surcharge for its late filing.

In response, the instant petition was filed.

The petition is **GRANTED**.

Petitioner has shown that inventor Mu Hwan Seo has refused to join in the filing of the above-identified application after having been presented with the application papers. Specifically, the statement of attorney Paul W. Davis establishes that the inventor was mailed the application papers, including the specification, claims and drawings, but failed to respond to the request that he sign the declaration. The copy of the letter from the non-signing inventor's attorney acknowledge's the non-signing inventor's receipt of the application papers and said inventor's refusal to execute the declaration.

The above-identified application and accompanying papers have been reviewed and found in compliance with 37 CFR 1.47(a). This application is hereby accorded Rule 1.47(a) status.

As provided in Rule 1.47(a), this Office will forward notice of this application's filing to the non-signing inventor at the address given in the petition. Notice of the filing of this application will also be published in the Official Gazette.

As the response to the Notice was submitted two months after

Application No. 09/687,048

the period for reply given in the Notice, a two month extension of time has been charged to deposit account no. 10-0447, as per the authorization contained in the instant petition.

After this decision is mailed, the above-identified application will be returned to the Office of Initial Patent Examination for issuance of a corrected filing receipt.

Telephone inquiries regarding this decision should be directed to Petitions Attorney Alesia M. Brown at (703) 305-0310.

Beverly M. Flanagan

Supervisory Petitions Examiner
Office of Petitions
Office of the Deputy Assistant Commissioner
for Patent Policy and Projects



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MU HWAN SEO 263 RIVER VALLEY ROAD #06-06 ASPEN HEIGHTS, SINGAPORE

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LETTER

In re Application of Lee, et al. Application No. 09/687,048 Filed: October 13, 2000 Attorney Dkt. No. 45475-00026 For: LEADFRAME AND SEMICONDUCTOR PACKAGE WITH IMPROVED SOLDER JOINT STRENGTH

Dear Mu Hwan Seo:

You are named as the inventor in the above-identified United States patent application filed under the provisions of 35 U.S.C. 116 (United States Code) and 37 CFR 1.47(a), Rules of Practice in Patent Cases. Should a patent be granted on the application you will be designated therein as a joint inventor.

As a named inventor you are entitled to inspect any paper in the file wrapper of the application, order copies of all or any part thereof (at a prepaid cost per 37 CFR 1.19) or make your position of record in the application. Alternatively, you may arrange to do any of the preceding through a registered patent attorney or agent presenting written authorization from you. If you care to join the application, counsel of record (see below) would presumably assist you. Joining in the application would entail the filing of an appropriate oath or declaration by you pursuant to 37 CFR 1.63.

Telephone inquiries regarding this communication should be directed to Petitions Attorney Alesia M. Brown at (703) 305-0310. Requests for information regarding your application should be directed to the File Information Unit at (703) 308-2733. Information regarding how to pay for and order a copy of the application, or a specific paper in the application, should be directed to Certification Division at (703) 308-9726 or 1-800-872-6382 (outside the Washington D.C. area).

Beverly M. Flanagan Supervisory Petitions Examiner Office of Petitions Office of the Deputy Commissioner for Patent Examination Policy

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